

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: J. TAKETATSU, et al.  
Serial No.: 10/585,461  
Filed: JULY 7, 2004  
Title: CIRCUIT CONNECTION MATERIAL, FILM-SHAPED CIRCUIT  
CONNECTION MATERIAL USING THE SAME, CIRCUIT  
MEMBER CONNECTION STRUCTURE AND  
MANUFACTURING METHOD THEREOF  
Group AU: 2881  
Examiner: TBA  
Confirm. No.: 5965

**INFORMATION DISCLOSURE STATEMENT  
UNDER 37 CFR 1.97 AND 1.98****Mail Stop: AMEND – NO FEE**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

October 24, 2007

SIR:

Pursuant to Applicants' duty of disclosure, enclosed please find a copy of an Official Action issued on July 24, 2007, in a corresponding Korean patent application, and a copy of the document cited therein. Also enclosed is an English-language abstract of the laid-open published application corresponding to the document cited in the enclosed Official Action. Further enclosed is a Form PTO/SB/08A, listing the enclosed documents.

This Information Disclosure Statement is being submitted prior to a first Office Action on the merits in the above-identified application. Accordingly, requirements of 37 CFR 1.97(b) are satisfied.

In any event, the following Statement is made under 37 CFR 1.97(e):

Each item of information contained in this Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.

While the document cited in the enclosed Official Action is not in English, it is respectfully submitted that requirements of 37 CFR 1.98(a)(3) are satisfied by the enclosed English abstract of Japanese Patent Publication No. 04-149237, corresponding to cited Japanese Patent No. 3004042.

In view of the foregoing, it is respectfully submitted that all applicable requirements of 37 CFR 1.97 and 1.98 have been satisfied, at least in connection with the enclosed document, cited in the enclosed Official Action. Consideration of the enclosed documents, upon examination of the above-identified application, is respectfully requested.

Applicants request any shortage or excess in fees due in connection with the filing of this paper be charged or credited to the Deposit Account of Antonelli, Terry, Stout & Kraus, LLP, Deposit Account No. 01-2135 (case: 1303.46354X00).

Respectfully submitted,

**ANTONELLI, TERRY, STOUT & KRAUS, LLP**

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